

**TTM technologies, inc. asia pacific's silicon platforms divison in shanghai receives world class supplier - zero defect award from spanson, inc.**

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for immediate release

HONG KONG - July 03, 2014 - TTM Technologies, Inc. (Nasdaq: TTMI) announced that its Silicon Platforms facility in Shanghai ("SMST-SP") received the World Class Supplier - Zero Defect Award from Spansion Inc. on June 16, 2014 for supplying top quality, zero defect substrate products in 2013.

Spansion's World Class Supplier - Zero Defect Award is awarded to suppliers based primarily on their responsiveness and quality performance.

"I am impressed to see SMST-SP shipping zero defect, quality products to Spansion and hope that this will continue into the future, " said Gene Daszko, Vice President of Quality at Spansion Inc.

"We would like to thank Spansion for this award and recognition! We appreciate our business relationship with Spansion and are committed to continue delivering top quality products to support them. We look forward to an even stronger relationship going forward and will continue to strive for excellence through continuous improvement," said Canice Chung, President of TTM's Asia Pacific Business Unit.

**Safe Harbor Statement**

This release contains forward-looking statements that relate to future events or performance. These statements reflect the company's current expectations, and the company does not undertake to update or revise these forward-looking statements, even if experience or future changes make it clear that any projected results expressed or implied in this or other company statements will not be realized. Furthermore, readers are cautioned that these statements involve risks and uncertainties, many of which are beyond the company's control, which could cause actual results to differ materially from the forward-looking statements. These risks and uncertainties include, but are not limited to, the company's dependence upon the electronics industry, the impact of the current economic crisis, the company's dependence upon a small number of customers, the unpredictability of and potential fluctuation in future revenues and operating results, increased competition from low-cost foreign manufacturers and other "Risk Factors" set forth in the company's most recent SEC filings.

**About TTM Technologies, Inc.**

TTM Technologies, Inc. is a major global printed circuit board manufacturer, focusing on quick-turn and technologically advanced PCBs and the backplane and sub-system assembly business. TTM stands for time-to-market, representing how the company's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at [www.ttmtech.com](http://www.ttmtech.com).

SMST-SP, a member of TTM Technologies, Inc. under the Asia Pacific Business Unit was established in 2002 to focus on the advanced technology IC substrate market including CSP, BOC, SIP, and RF and memory modules. SMST-SP is located in Shanghai with about 900 employees.

**Company**

TTM Technologies  
(ticker: TTMI, exchange: NASDAQ)

**Release Info**

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**Contact**

Audrey Sim

V.P. Marketing, Asia Pacific

+852 2660 4287

[audrey.sim@ttmtech.com.hk](mailto:audrey.sim@ttmtech.com.hk)